DSC5G03

Silicon NPN epitaxial planar type

For high-frequency amplification DSC2G03 in SMini3 type package

■ Features

- High transition frequency f_T
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

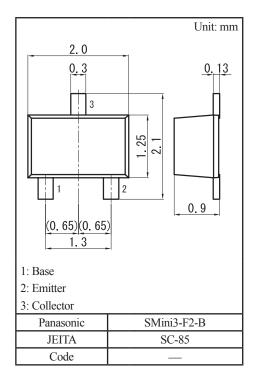
■ Marking Symbol: C6

■ Packaging

DSC5G03×0L Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V _{CBO}	30	V
Collector-emitter voltage (Base open)	V _{CEO}	20	V
Emitter-base voltage (Collector open)	V_{EBO}	3	V
Collector current	I_{C}	50	mA
Collector power dissipation	P _C	150	mW
Junction temperature	T_j	150	°C
Operating ambient temperature	T _{opr}	-40 to +85	°C
Storage temperature	T _{stg}	-55 to +150	°C



■ Electrical Characteristics $T_a = 25$ °C±3°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_C = 100 \mu\text{A}, I_E = 0$	30			V
Emitter-base voltage (Collector open)	V_{EBO}	$I_E = 10 \mu A, I_C = 0$	3			V
Base-emitter voltage	$V_{ m BE}$	$V_{CE} = 10 \text{ V}, I_{C} = 2 \text{ mA}$		740		mV
Forward current transfer ratio	h_{FE}	$V_{CE} = 10 \text{ V}, I_{C} = 2 \text{ mA}$	25		250	_
Transition frequency *1,2	f_T	$V_{CE} = 10 \text{ V}, I_{C} = 15 \text{ mA}$	800		1600	MHz
Reverse transfer capacitance (Common emitter)	C _{re}	$V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ mA}, f = 10.7 \text{ MHz}$		0.9		pF
Reverse transfer capacitance (Common base)	C _{rb}	$V_{CB} = 6 \text{ V}, I_{C} = 0, f = 1 \text{ MHz}$		0.7		pF
Power gain	PG	$V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ mA}, f = 200 \text{ MHz}$		20		dB

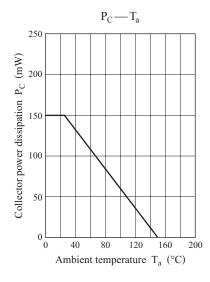
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

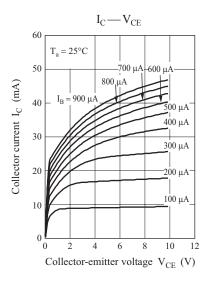
*2: Rank classification

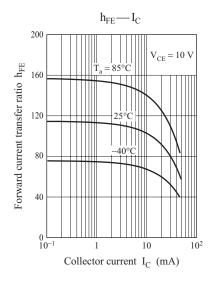
Code	Т	S	0
Rank	Т	S	No-rank
f_{T}	800 to 1400	1 400 to 1 600	800 to 1600
Marking Symbol	C6T	C6S	C6

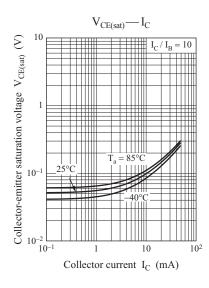
Product of no-rank is not classified and have no marking symbol for rank.

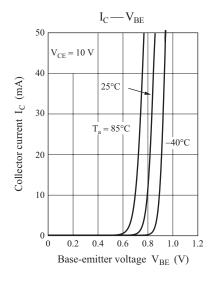
^{2. *1:} Pulse measurement

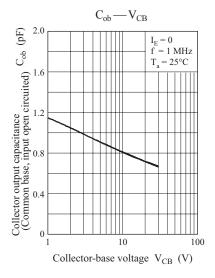


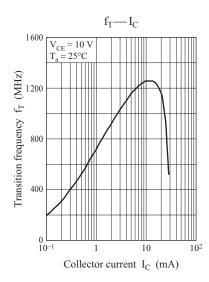








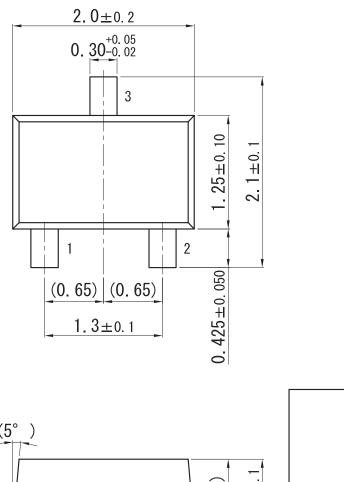


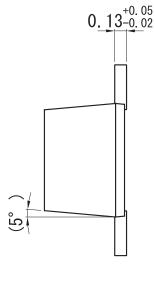


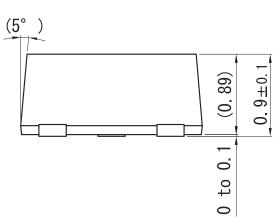
Ver. BED 2

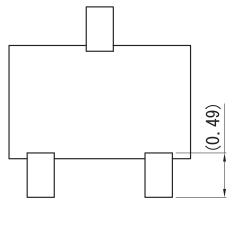
SMini3-F2-B

Unit: mm

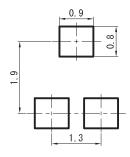








■ Land Pattern (Reference) (Unit: mm)



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